

## SMT MIGRO HEADER

## SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?FTSH

Insulator Material: Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze Plating:
Sn or Au over $50 \mu^{\prime \prime}$ $(1,27 \mu \mathrm{~m}) \mathrm{Ni}$
Current Rating:
$1.75 \mathrm{~A} @ 80^{\circ} \mathrm{C}$ ambient Operating Temp Range: $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ RoHS Compliant: Yes
Processing: Lead-Free Solderable: Yes
SMT Lead Coplanarity:
-MT \& -DV Tail Option:
( $0,10 \mathrm{~mm}$ ) .004" $\max (02-25)$
-MT \& -DH Tail Option:
( $0,15 \mathrm{~mm}$ ) . $006^{\prime \prime} \max (26-50)$

| $1,27 \mathrm{~mm}$ |  |
| :--- | :--- |
| FTSH/CLP | Rated @ 3dB | FTSH/CLP Insertion Loss

$5,13 \mathrm{~mm}$ Stack Height

|  |  |
| :--- | :--- |
| Single-Ended |  |
| Signaling | $7.0 \mathrm{GHz} / 14 \mathrm{Gbps}$ | Differential Pair Signaling Performan Performance data for other stack heights and complete test data available at www.samtec.com?FTSH or contact sig@samtec.com.

Note: Some sizes, styles and options are non-standard, non-returnable.

Note: See SFM/TFM for positive alignment feature.

Mates with:




